



Power MOSFETS

DATASHEET

LM45015NAM8A

N-Channel
Enhancement Mode MOSFET

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Quality Management Systems
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description

LFPACK56		Symbol	Product Summary
Top view	Bottom view		
			Symbol
			N-Channel
			Unit
		V_{DSS}	40 V
		$R_{DS(ON)-Max}$	1.4 mΩ
		ID	207 A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and R_g Tested
- Moisture Sensitivity Level MSL1

Applications

- DC-to-DC converters
- Switch Mode Power Supply
- Brushless DC motor control

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM45015NAM8A	LFPACK56	Tape & Reel	4000 / Tape & Reel	45015 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note : = Lot CodeAbsolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	40	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	175	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
I_S	Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	A
I_{SP}	Diode Pulse Current	$T_c=25^\circ\text{C}$	$400^{\circ\text{C}}$
I_{DM}	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	A
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	
		$T_c=100^\circ\text{C}$	A
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	W
		$T_c=100^\circ\text{C}$	
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	
$I_{AS}^{\circ\text{C}}$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	A
		$L=0.5\text{mH}$	
$E_{AS}^{\circ\text{C}}$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	mJ
		$L=0.5\text{mH}$	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	1.6	$^\circ\text{C/W}$
$R_{\theta JA}^{\circ\text{C}}$	Thermal Resistance-Junction to Ambient	45	$^\circ\text{C/W}$

Note ① : Max. current is limited by bonding

Note ② : UIS tested and pulse width are limited by maximum junction temperature 175°C Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

LM45015NAM8A

N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=36\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	1	1.7	2.3	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=25\text{A}$	-	1.1	1.4	mΩ
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{DS}}=15\text{A}$	-	2.2	2.8	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	34	-	S
Dynamic Characteristics ^⑤						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	1	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=20\text{V}$, Freq.=1MHz	-	3792	-	pF
C_{oss}	Output Capacitance		-	1260	-	
C_{rss}	Reverse Transfer Capacitance		-	72	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=20\text{V}$, $I_{\text{D}}=1\text{A}$, $R_{\text{GEN}}=1\Omega$	-	15	-	nS
t_{r}	Turn-on Rise Time		-	14	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	79	-	
t_{f}	Turn-off Fall Time		-	93	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}$, $V_{\text{DS}}=20\text{V}$, $I_{\text{D}}=25\text{A}$		23		nC
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=20\text{V}$, $I_{\text{D}}=25\text{A}$	-	50	-	nC
Q_{gs}	Gate-Source Charge		-	12	-	
Q_{gd}	Gate-Drain Charge		-	5	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=25\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.75	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=12.5\text{A}$, $V_{\text{R}}=30\text{V}$ $dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	57	-	nS
Q_{rr}	Reverse Recovery Charge		-	81	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

LM45015NAM8A

N-Channel Typical Characteristics

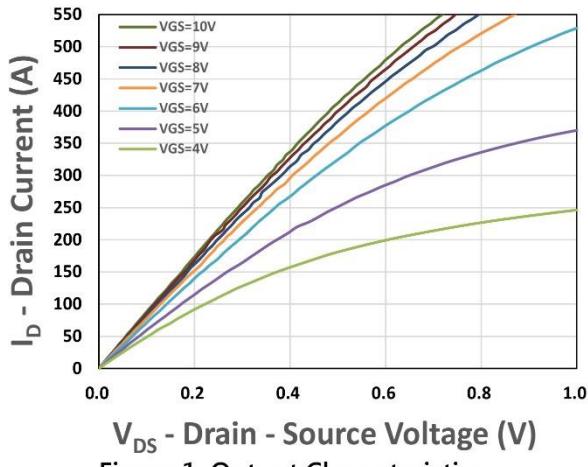


Figure 1. Output Characteristics

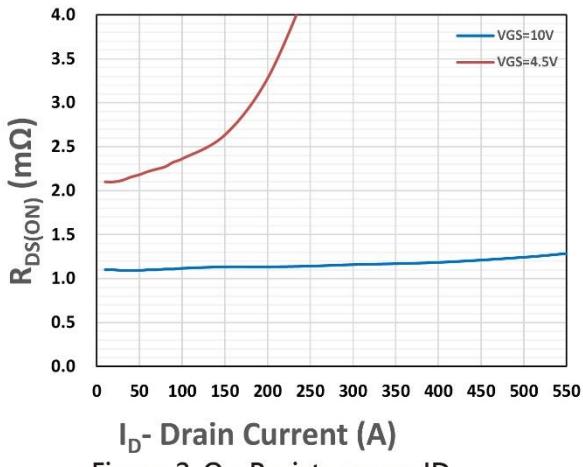


Figure 2. On-Resistance vs. ID

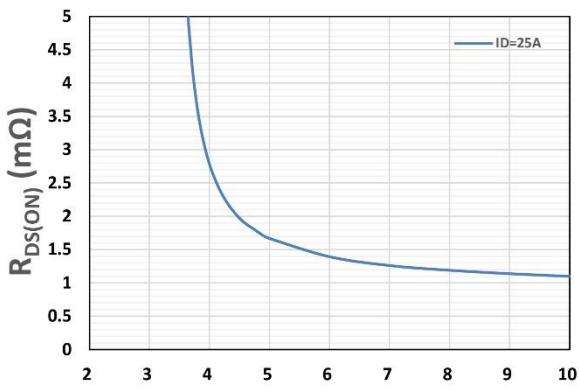


Figure 3. On-Resistance vs. VGS

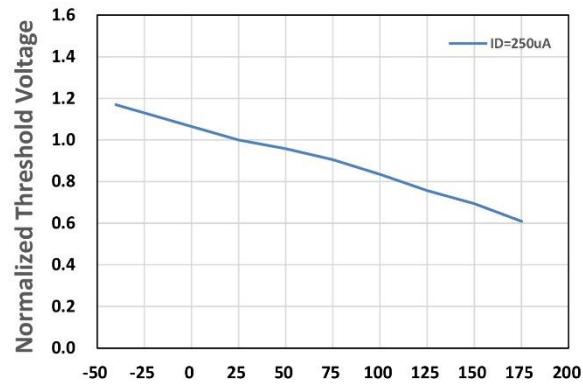


Figure 4. Gate Threshold Voltage

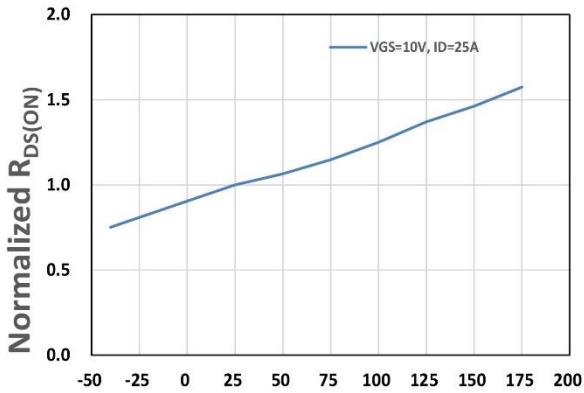


Figure 5. Drain-Source On Resistance

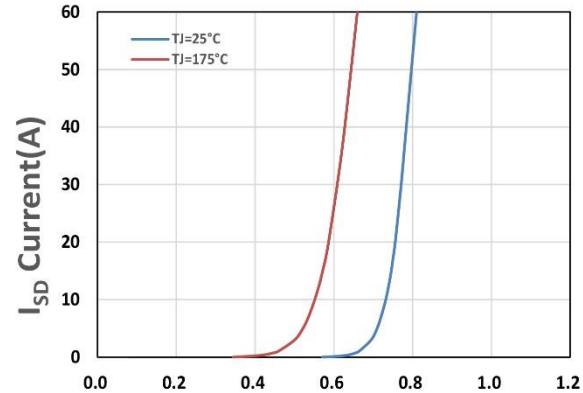
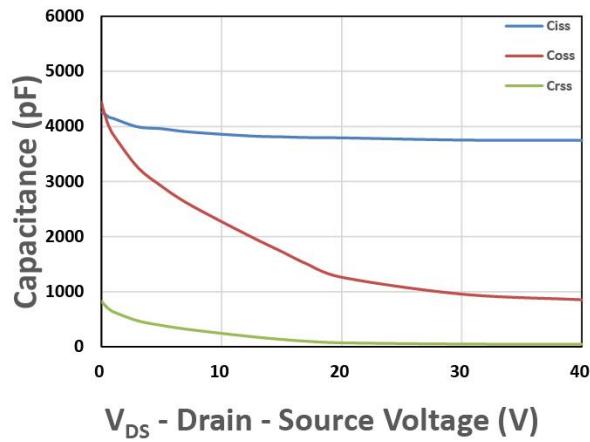


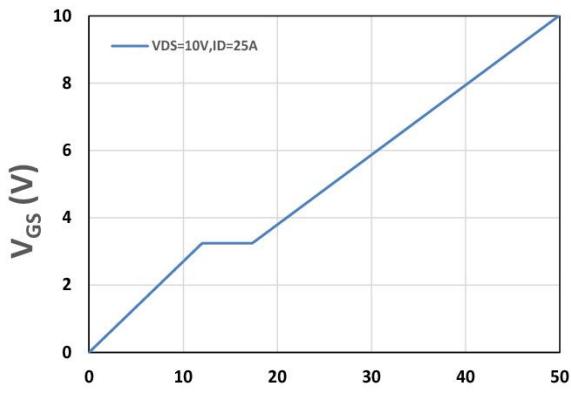
Figure 6. Source-Drain Diode Forward

LM45015NAM8A



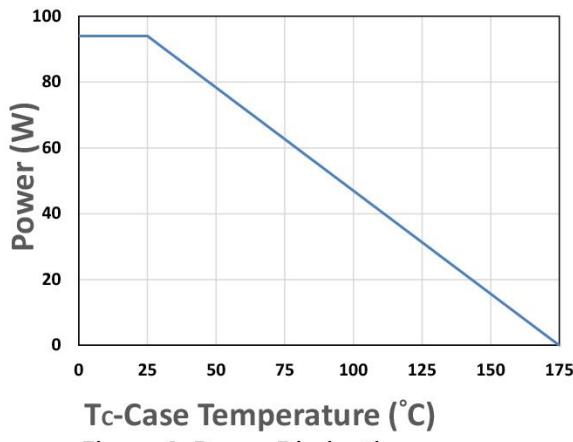
V_{DS} - Drain - Source Voltage (V)

Figure 7. Capacitance



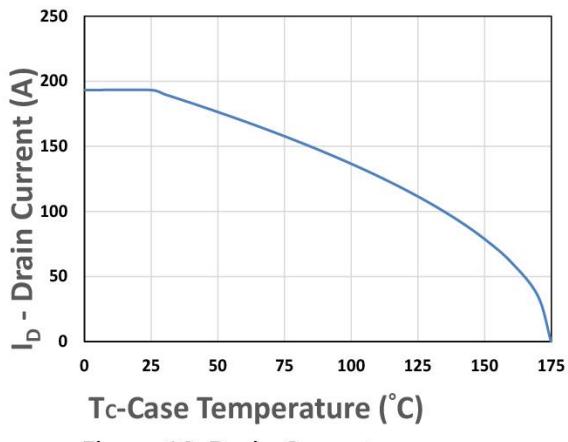
V_{GS} (V)

Q_g, Total Gate Charge (nC)



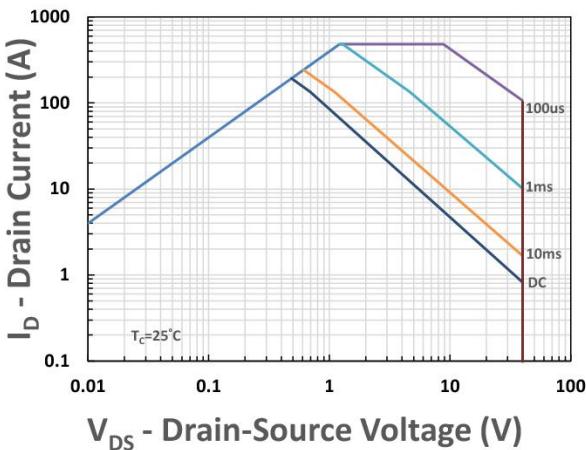
T_c-Case Temperature (°C)

Figure 9. Power Dissipation



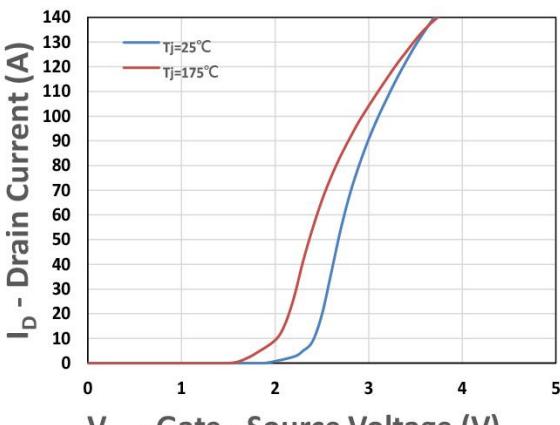
T_c-Case Temperature (°C)

Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)

Figure 11. Safe Operating Area



V_{GS} - Gate - Source Voltage (V)

Figure 12. Transfer Characteristics

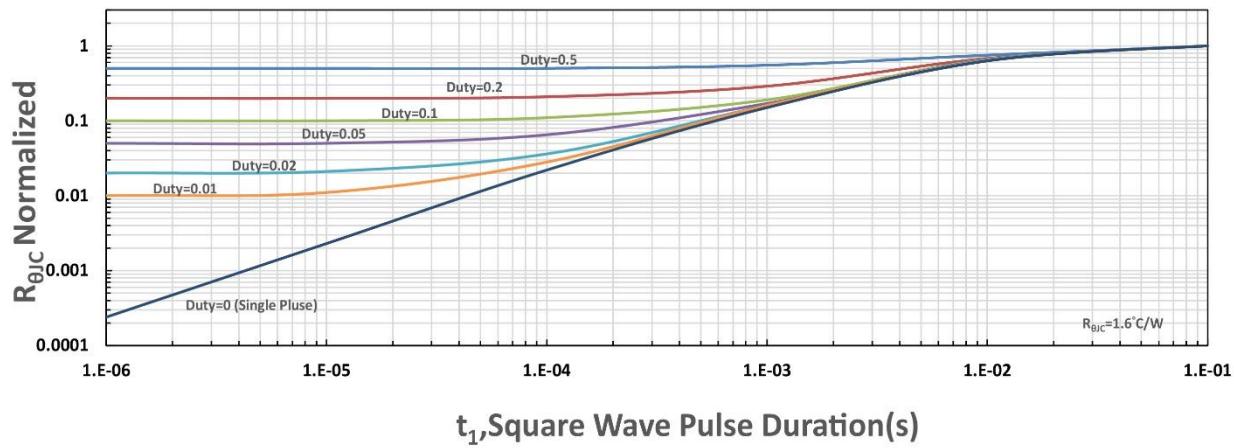


Figure 13. $R_{\theta JC}$ Transient Thermal Impedance